2SC3944, 2SC3944A

Silicon NPN epitaxial planar type

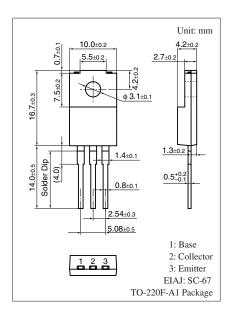
For low-frequency driver and high power amplification Complementary to 2SA1535 and 2SA1535A

■ Features

- \bullet Excellent collector current I_C characteristics of forward current transfer ratio h_{FE}
- High transition frequency f_T
- A complementary pair with 2SA1535 and 2SA1535A, is optimum for the driver stage of a 60 W to 100 W output amplifier
- Full-pack package which can be installed to the heat sink with one screw

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage	2SC3944	V_{CBO}	150	V
(Emitter open)	2SC3944A		180	
Collector-emitter voltage	2SC3944	V _{CEO}	150	V
(Base open)	2SC3944A		180	
Emitter-base voltage (Col	V_{EBO}	5	V	
Collector current	I_C	1	A	
Peak collector current	I_{CP}	1.5	A	
Collector power	$T_C = 25^{\circ}C$	P _C	15	W
dissipation			2.0	
Junction temperature	T_{j}	150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	



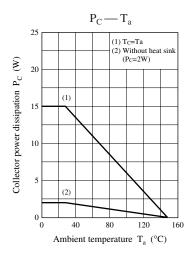
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

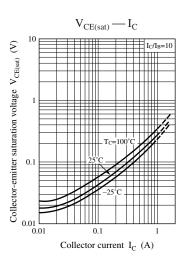
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SC3944	V _{CEO}	$I_C = 1 \text{ mA}, I_B = 0$	150			V
(Base open)	2SC3944A			180			
Emitter-base voltage (Collector open)		V _{EBO}	$I_E = 10 \ \mu A, I_C = 0$	5			V
Collector-base cutoff current	2SC3944	I_{CBO}	$V_{CB} = 150 \text{ V}, I_{E} = 0$			10	μΑ
(Emitter open)	2SC3944A		$V_{CB} = 180 \text{ V}, I_{E} = 0$			10	
Forward current transfer ratio		h _{FE1} *	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	65	160	330	_
		h _{FE2}	$V_{CE} = 5 \text{ V}, I_{C} = 500 \text{ mA}$	50	100		
Collector-emitter saturation voltage		V _{CE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		0.5	2.0	V
Base-emitter saturation voltage		V _{BE(sat)}	$I_C = 500 \text{ mA}, I_B = 50 \text{ mA}$		1.0	2.0	V
Transition frequency		f_T	$V_{CE} = 10 \text{ V}, I_{C} = 50 \text{ mA}, f = 10 \text{ MHz}$		200		MHz
Collector output capacitance		C _{ob}	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		30	50	pF
(Common base, input open	circuited)						

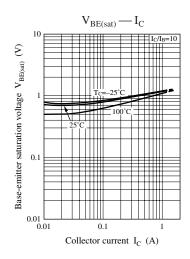
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

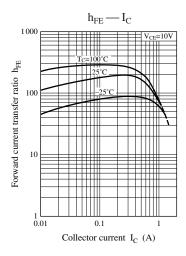
2. *: Rank classification

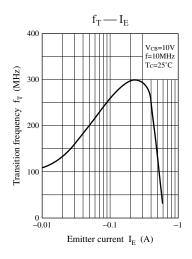
Rank	Р	Q	R	S
$h_{\rm FE1}$	65 to 110	90 to 155	130 to 220	185 to 330

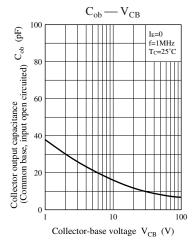


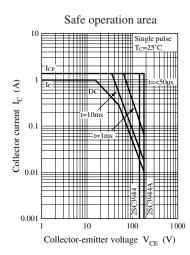












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